



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Donald Craig Foster, Kelly Robbins McKendrick, Sr.  
Assignee: Amkor Technology, Inc.  
Title: Leadframe Having Fine Pitch Bond Fingers Formed Using Laser cutting Method  
Application No.: 09/895,501 Filing Date: June 29, 2001  
Examiner: David E. Graybill Group Art Unit: 2827  
Docket No.: M-11315 US

San Jose, California  
October 28, 2002

COMMISSIONER FOR PATENTS  
Washington, D.C. 20231

**INFORMATION DISCLOSURE STATEMENT  
UNDER 37 CFR § 1.97(b)**

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the documents listed on the accompanying form PTO-1449 are called to the attention of the Examiner for the above patent application. Copies of these documents are enclosed.

Citation of these documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;
2. a representation that a search has been made, other than as described above; or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

EXPRESS MAIL LABEL NO:

EV 160 616 163 US

Respectfully submitted,

*James E. Parsons*  
James E. Parsons  
Attorney for Applicants  
Reg. No. 34,691

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Atty Docket No.

Serial No.

M-11315 US

09/895,501

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

Applicants

Donald Craig Foster, Kelly Robbins  
McKendrick, Sr.

Filing Date

June 29, 2001

Group

2827

## U.S. Patent Documents

*Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA 5,864,173	1/26/99	Fogelson	257	666	
	AB 5,994,768	11/30/99	Fogelson	257	666	
	AC 6,087,204	7/11/00	Fogelson	438	123	
	AD 6,229,200 B1	5/8/01	McLellan, et al.	257	666	
	AE 5,521,429	5/28/96	Aono, et al.	257	676	
	AF 6,143,981	11/7/00	Glenn	174	52.4	
	AG 5,977,613	11/2/99	Takata, et al.	257	666	
	AH 5,859,471	1/12/99	Kuraishi, et al.	257	666	
	AI 5,977,630	11/2/99	Woodworth, et al.	257	712	
	AJ 4,707,724	11/17/87	Suzuki, et al.	357	71	
	AK 6,130,115	10/10/00	Okumura, et al.	438	124	

## Foreign Patent Documents

	Document	Date	Country	Class	Subclass	Translation	
						Yes	No
	AL 9-8205	1/10/97	Japan	H01L	23/50	X	
	AM 9-8206	1/10/97	Japan	H01L	23/50	X	
	AN 9-8207	1/10/97	Japan	H01L	23/50	X	
	AO 9-92775	4/4/97	Japan	H01L	23/50	X	
	AP 55-163868 w/ Eng. Abstract	12/20/80	Japan	H01L	23/48		X

## OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AQ	"Microstructured Solder Mask by Means of Laser," IBM Technical Disclosure Bulletin, November 1993, Volume 36, Issue 11, page 589.
AR	
AS	

Examiner

Date Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.

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Sheet 2 of

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U.S. Patent Documents

*Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
AA	6,025,640	2/15/00	Yagi, et al.	257	666	
AB	6,198,171 B1	3/6/01	Huang, et al.	257	787	
AC	6,242,281 B1	6/5/01	McLellan, et al.	438	106	
AD	6,281,568 B1	8/28/01	Glenn, et al.	257	684	
AE	6,225,146 B1	5/1/01	Yamaguchi, et al.	438	123	
AF						
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AH						
AI						
AJ						
AK						

Foreign Patent Documents

Document	Date	Country	Class	Subclass	Translation
AL 6-92076 w/Eng. Abstract	4/5/94	Japan	H01L	23/00	Yes X
AM 99/67821 WO	12/29/99	PCT	H01L	23/495	
AN					
AO					
AP					

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